

Invitation Letter for HDIS 2023

Songwen Pei

University of Shanghai for Science and Technology

Dear Songwen Pei,

It is our great pleasure to invite you to attend the 5th International Conference on High Performance Big Data and Intelligent Systems (HDIS 2023) (https://www.hdis.world/). The conference will be held in Macua, China from 6 to 8 December 2023.

HDIS 2023 aims at bringing together scientists, engineers, students and others working in these areas from around the world to share their latest results on the hot topics about High Performance Computing, Big Data, AI, etc. It will provide an opportunity for learning the state-of-the-art and discussing the past achievements and future directions of intelligent technology as well as the development of intelligent manufacturing industry. World leading experts and well-known scholars will be invited to give keynote speeches, and exchange ideas around the themes.

Please note that you are responsible for the payment of all fees and expenses related to the participation in the conference as well as any necessary insurance for health and travel. This invitation letter does not include any financial aid such as waived fee, financial support or free accommodation. We look forward to seeing you in Macau!

Yours faithfully,

Prof. Cheng-Zhong Xu

General Chair of HDIS 2023

Dean of Faculty of Science and Technology, University of Macau

Email: czxu@um.edu.mo